



284

2800

PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Akihiro MURATA

Application No.: 09/245,288

Filed: February 5, 1999

Docket No.: 101937

For: SEMICONDUCTOR APPARATUS SUBSTRATE, SEMICONDUCTOR APPARATUS, AND METHOD OF MANUFACTURING THEREOF AND ELECTRONIC APPARATUS

RECEIVED
AUG -2 2001
TO 2300 MAIL ROOM

#171
8-17-01
Payton

PRELIMINARY AMENDMENT

Director of the U.S. Patent and Trademark Office
Washington, D. C. 20231

Sir:

Further to the July 19 personal interview with Examiner Graybill and prior to initial examination of the continued prosecution application filed July 2, 2001, please amend the above-identified application as follows:

IN THE CLAIMS:

Please replace claims 1 and 7 as follows:

- ① 1
1. (Twice Amended) A semiconductor apparatus, comprising:
- a substrate main body having a delineated mounting surface for mounting the semiconductor device;
- a plurality of leads formed on the mounting surface, the plurality of leads radially extending from a peripheral area toward a central area of the substrate main body;
- and